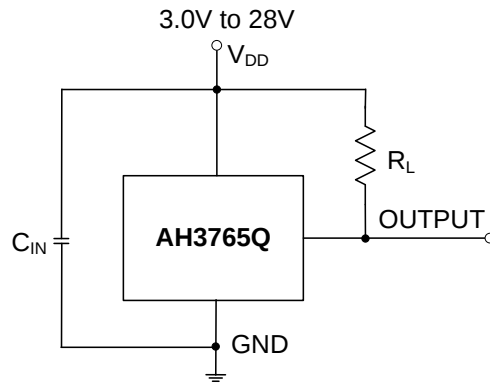


Typical Applications Circuit



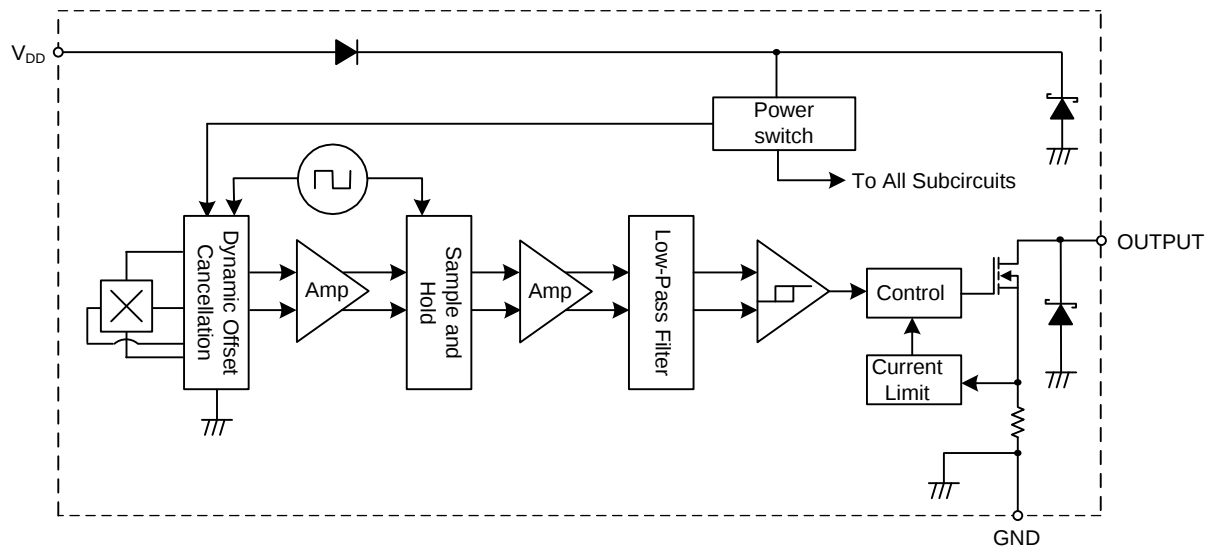
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SC59, SOT23 and SIP-3

Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Functional Block Diagram



Absolute Maximum Ratings (Notes 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic	Value	Unit
V _{DD}	Supply Voltage (Note 6)	32	V
V _{DDR}	Reverse Supply Voltage (Note 6)	-32	V
V _{OUT_MAX}	Output Off Voltage (Note 6)	32	V
I _{OUT}	Continuous Output Current	60	mA
I _{OUT_R}	Reverse Output Current	-50	mA
B	Magnetic Flux Density	Unlimited	
P _D	Package Power Dissipation	SIP-3	mW
		SC59 and SOT23	
T _S	Storage Temperature Range	-65 to +165	°C
T _J	Maximum Junction Temperature	+150	°C
ESD HBM	Electros Static Discharge Withstand - Human Body Model (HBM)	8	kV
ESD MM	Electros Static Discharge Withstand - Machine Model (MM)	800	V
ESD CDM	Electros Static Discharge Withstand - Charged Device Model (CDM)	2	kV

- Notes:
- Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
 - The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +150°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V _{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +150	°C

Electrical Characteristics (Notes 7 & 8) (@T_A = -40°C to +150°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{OUT_ON}	Output On Voltage	I _{OUT} = 20mA, B > B _{op}	-	0.2	0.4	V
I _{LKG}	Output Leakage Current (when output is off)	V _{OUT} = 28V, B < B _{rp} , Output off	-	<0.1	10	μA
I _{DD}	Supply Current	Output open, T _A = +25°C	-	3	3.5	mA
		Output open, T _A = -40°C to +150°C	-	-	4	mA
I _{DD_R}	Reverse Supply Current	V _{DD} = -18V, T _A = +25°C	-	0.6	-	μA
		V _{DD} = -18V, T _A = -40°C to +150°C	-	0.6	1,500	μA
		V _{DD} = -28V, T _A = +25°C	-	1.6	-	μA
		V _{DD} = -28V, T _A = -40°C to +150°C	-	1.6	2,500	μA
t _{P_ON}	Device Power-On Time (start-up time)	V _{DD} ≥ 3V, B > B _{op} (Note 7)	-	10	-	μs
f _c	Chopping Frequency	V _{DD} ≥ 3V	-	800	-	kHz
t _d	Response Time Delay (time from magnetic threshold reached to the start of the output rise or fall)	(Note 9)	-	3.75	-	μs
t _r	Output Rising Time (external pull-up resistor R _L and load capacitance dependent)	R _L = 1kΩ, C _L = 20pF	-	0.2	1	μs
t _f	Output Falling Time (Internal switch resistance and load capacitance dependent)	R _L = 1kΩ, C _L = 20pF	-	0.1	1	μs
I _{OCL}	Output Current Limit	B > B _{op} , (Note 10)	30	-	55	mA
V _Z	Zener Clamp Voltage	I _{DD} = 5mA	28	-	-	V

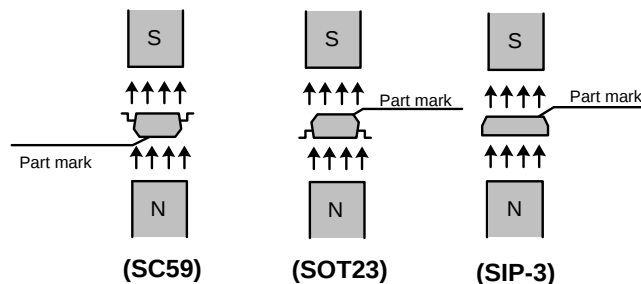
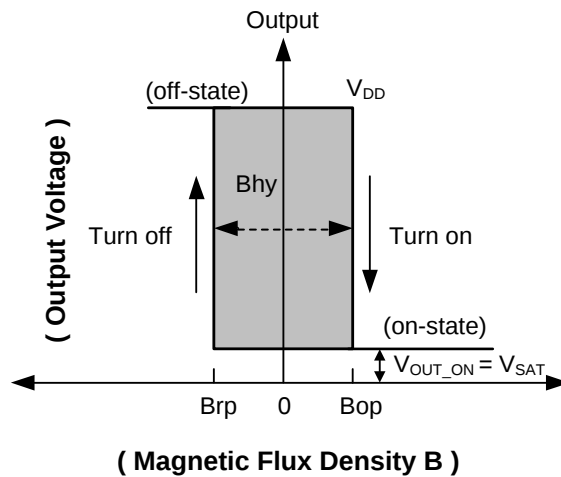
- Notes:
- When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10μs typical from the operating voltage reaching 3V.
 - Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
 - Guaranteed by design, process control and characterization. Not tested in production.
 - The device will limit the output current I_{OUT} to current limit of I_{OCL}.

Magnetic Characteristics (Notes 11 & 12) ($T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$, $V_{DD} = 3.0\text{V}$ to 28V , unless otherwise specified)

(1mT=10 Gauss)

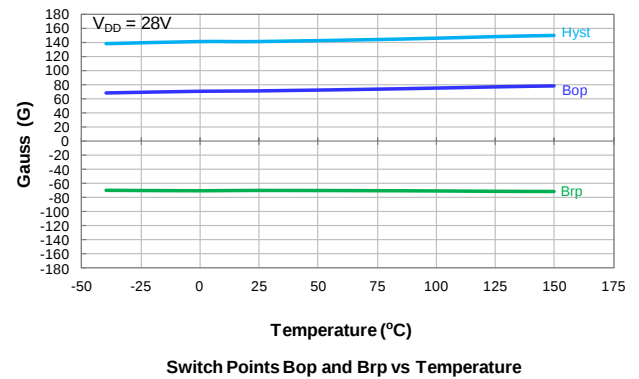
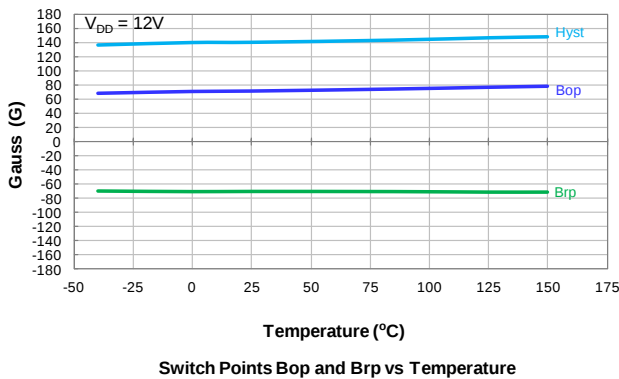
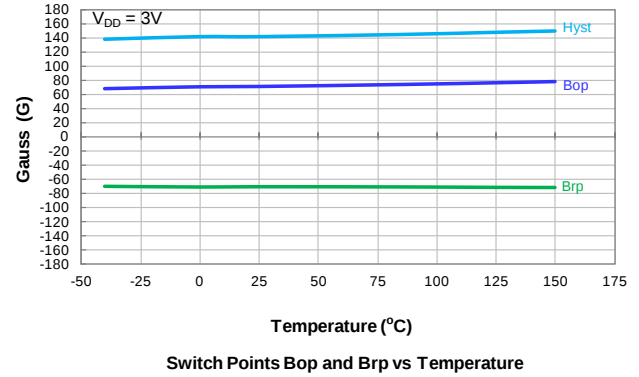
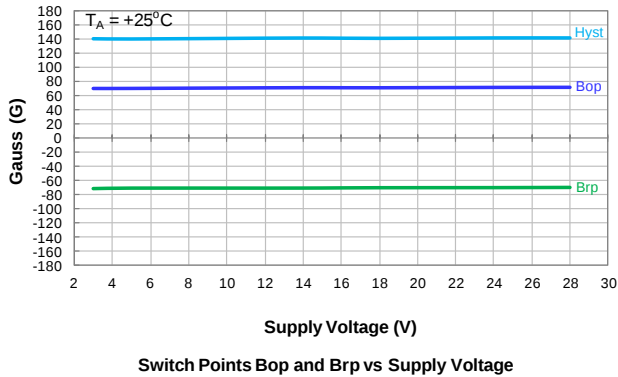
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
B_{ops} (South pole to part marking side for SOT23 and SIP-3 packages; South pole to the non-part marking side for SC59 package. See diagram below)	Operation Point	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	70	-	Gauss
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	50	70	90	
B_{rps} (North pole to part marking side for SOT23 and SIP-3 packages; North pole to the non-part marking side for SC59 package. See diagram below)	Release Point	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	-70	-	
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	-90	-70	-50	
B_{hy} ($ B_{opx} - B_{rpx} $)	Hysteresis (Note 13)	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	140	-	
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	100	140	180	

- Notes:
- When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10 μs typical from the operating voltage reaching 3V.
 - Typical values are defined at $T_A = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
 - Maximum and minimum hysteresis is guaranteed by design, process control and characterization.

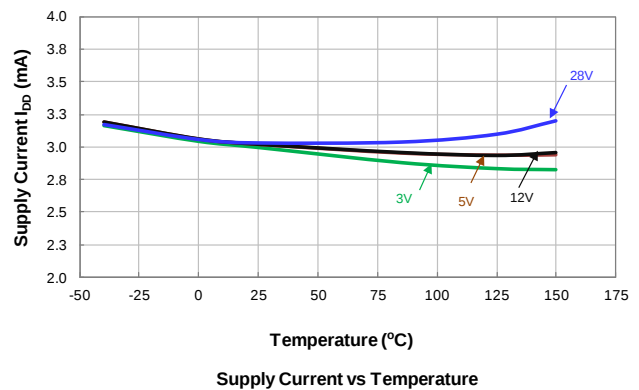
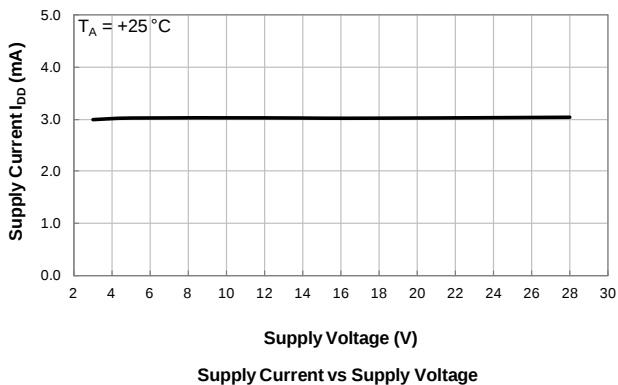


Typical Operating Characteristics

Output Switch Operate and Release Points (Magnetic Thresholds) – B_{op} and B_{rp}

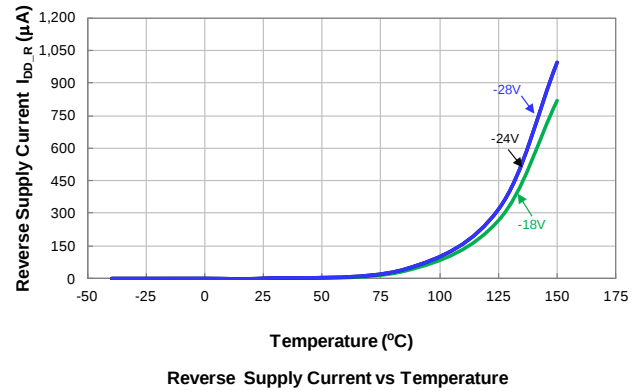
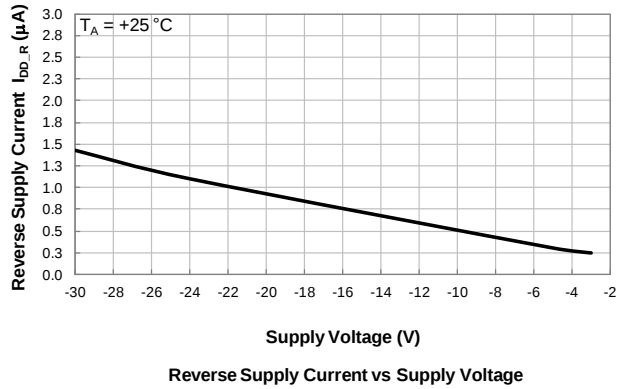


Supply Current

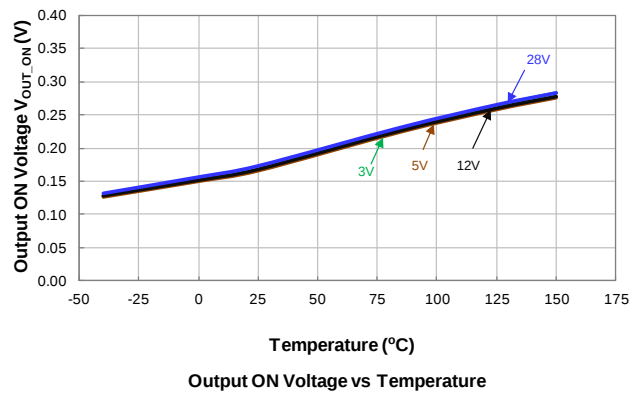
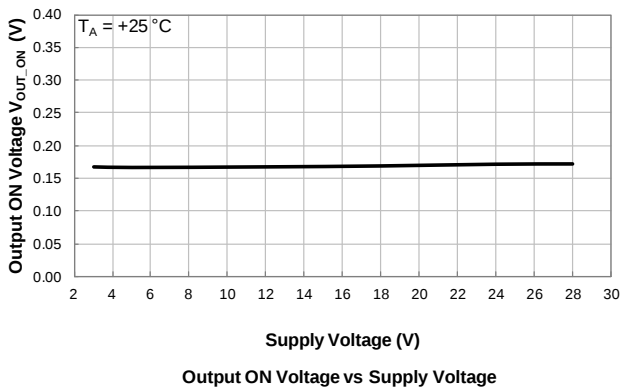


Typical Operating Characteristics (cont.)

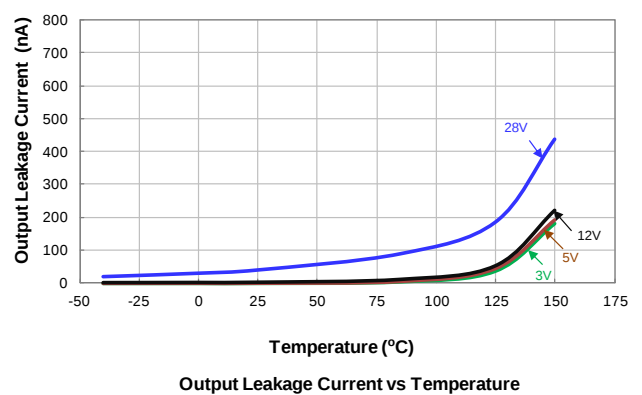
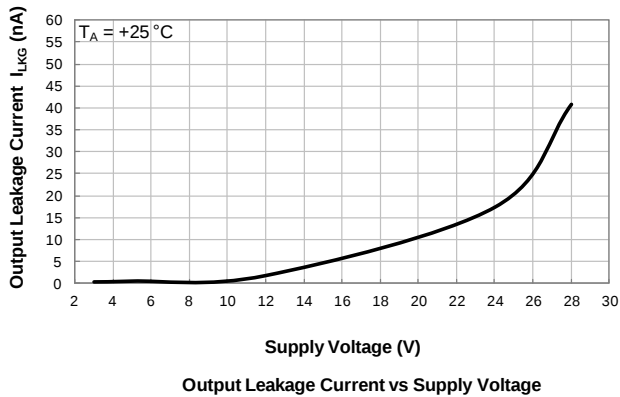
Reverse Supply Current



Output Switch On Voltage

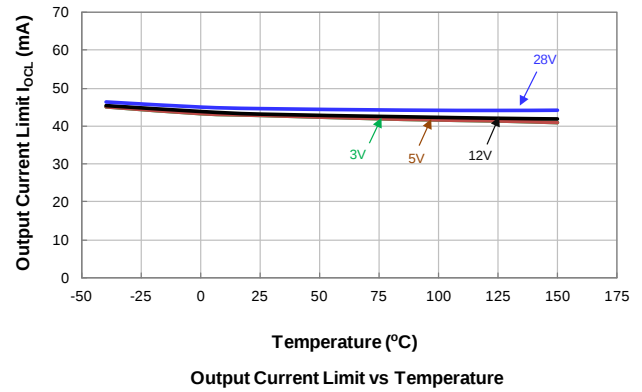
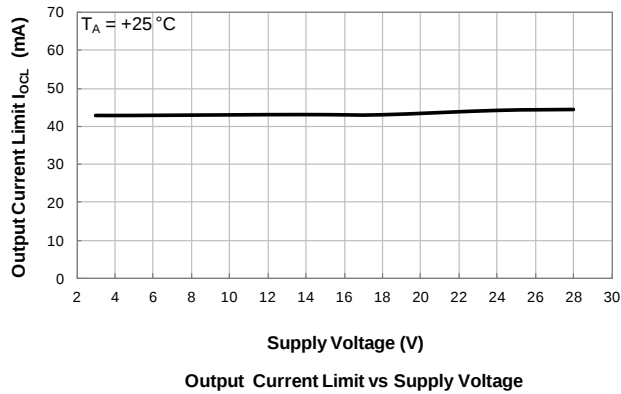


Output Switch Leakage Current



Typical Operating Characteristics (cont.)

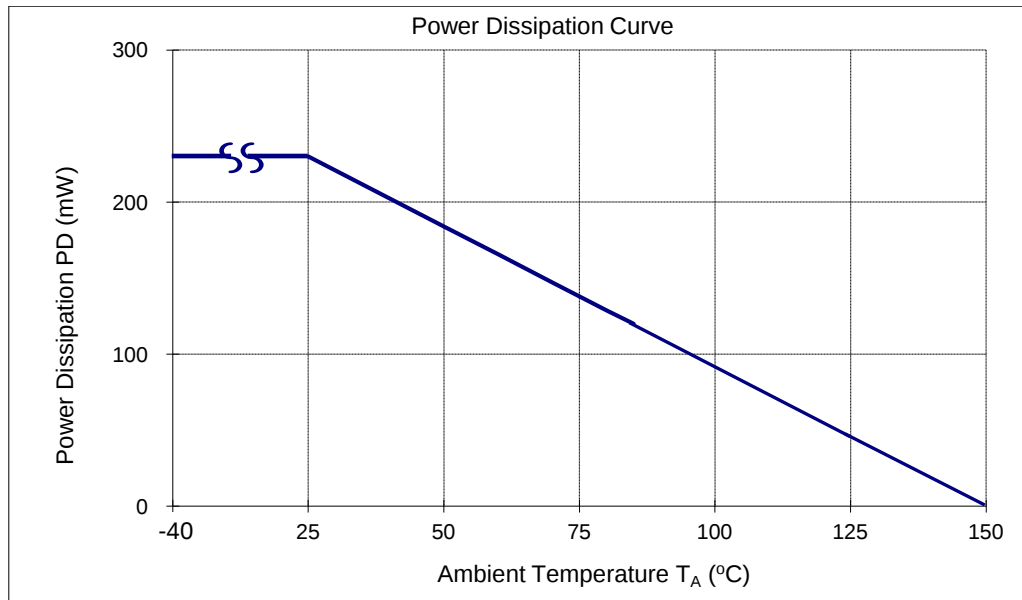
Output Current Limit



Thermal Performance Characteristics

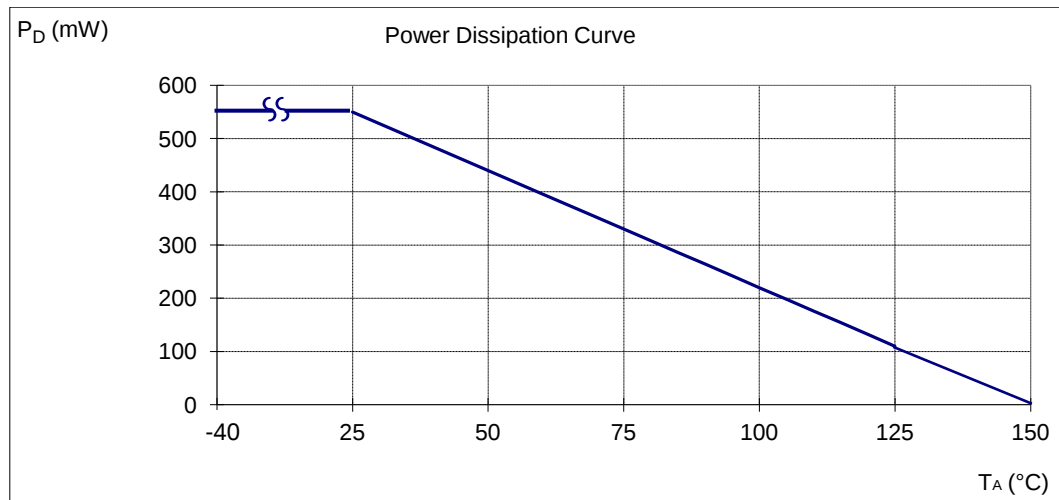
(1) Package type: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0

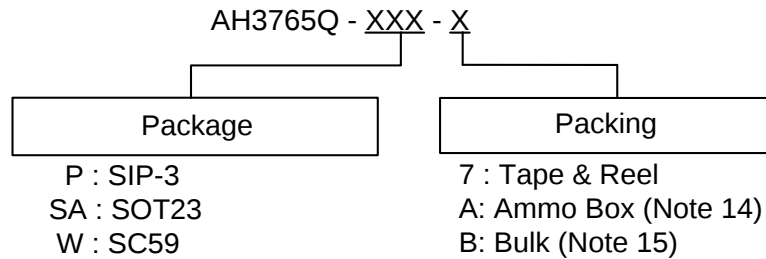


(2) Package type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0



Ordering Information



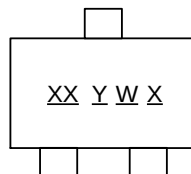
Part Number	Package Code	Packaging	Bulk		7" Tape and Reel		Ammo Box	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3765Q-P-A	P	SIP-3	NA	NA	NA	NA	4,000/Box	-A
AH3765Q-P-B	P	SIP-3	1,000	-B	NA	NA	NA	NA
AH3765Q-SA-7	SA	SOT23	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH3765Q-W-7	W	SC59	NA	NA	3,000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 Spread Lead.
15. Bulk is for SIP-3 Straight Lead.

Marking Information

(1) Package Type: SC59 and SOT23

(Top View)

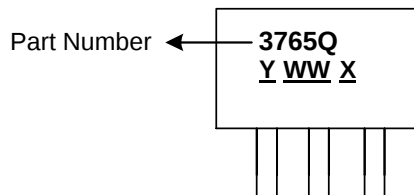


XX : Identification code
Y : Year 0 to 9
W : Week : A to Z : 1 to 26 week;
 a to z : 27 to 52 week; z represents
 52 and 53 week
X : Internal code

Part Number	Package	Identification Code
AH3765Q	SC59	YP
AH3765Q	SOT23	WP

(2) Package Type: SIP-3

(Top View)



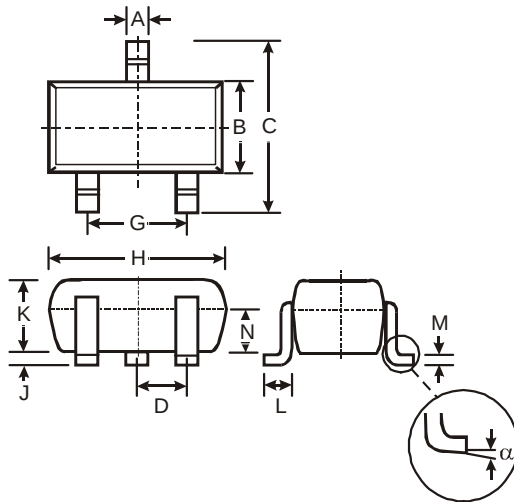
Y : Year : 0~9
WW : Week : 01~52, "52" represents
 52 and 53 week
X : Internal Code

Part Number	Package	Identification Code
AH3765Q	SIP-3	3765Q

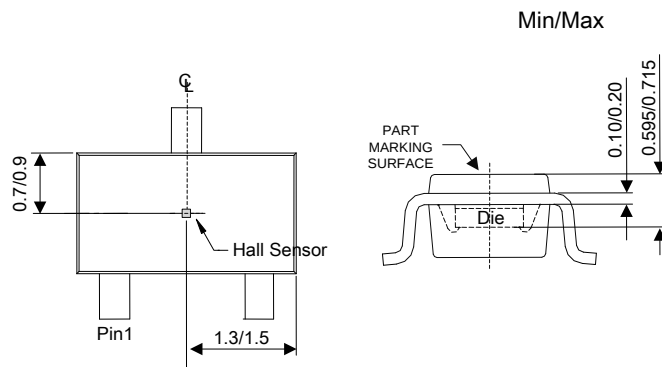
Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

(1) Package Type: SC59



SC59			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All Dimensions in mm			

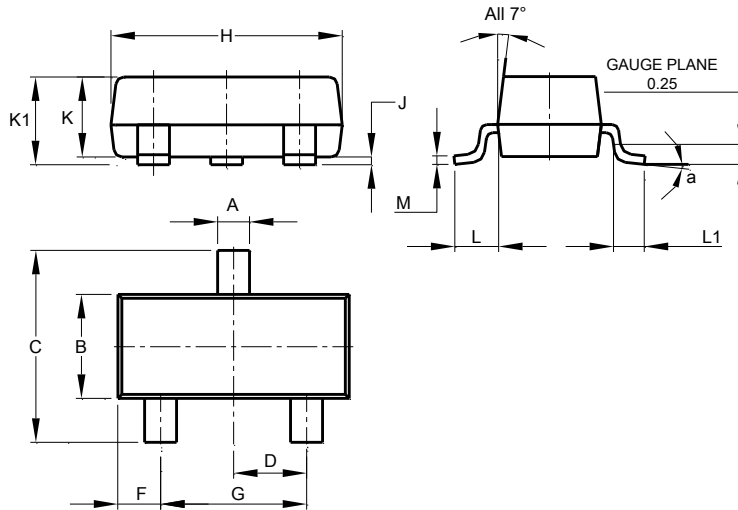


Sensor Location

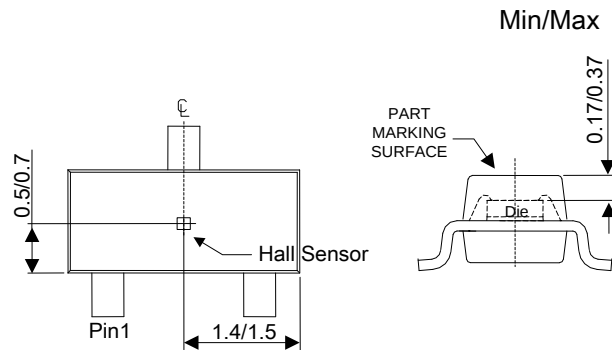
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

(2) Package Type: SOT23



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			



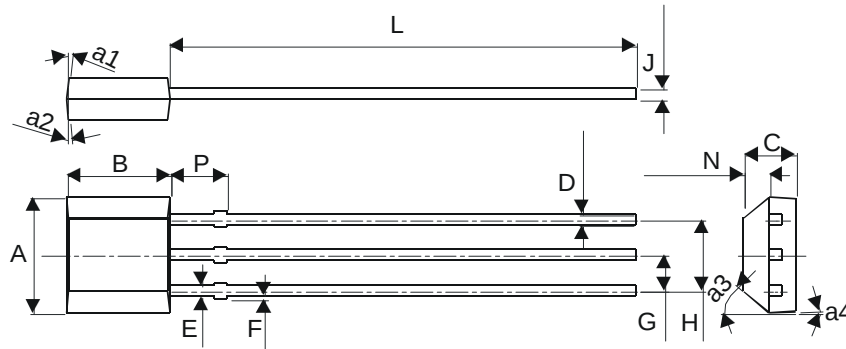
Sensor Location – To be updated

Package Outline Dimensions (cont.) (All dimensions in mm.)

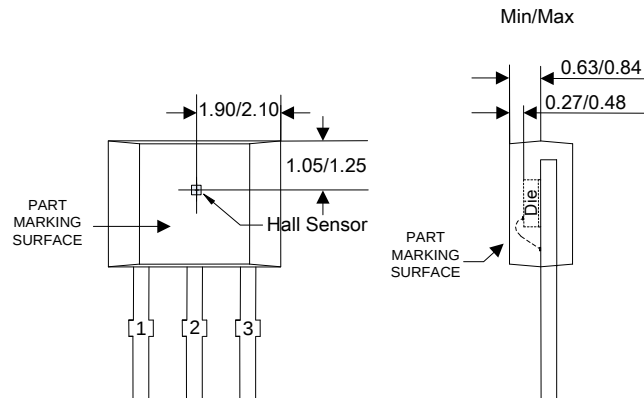
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

(3) Package Type: SIP-3 Bulk

Sensor location to be added



SIP-3 (Bulk)		
Dim	Min	Max
A	3.9	4.3
a1	5° Typ	
a2	5° Typ	
a3	45° Typ	
a4	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.33	0.432
E	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

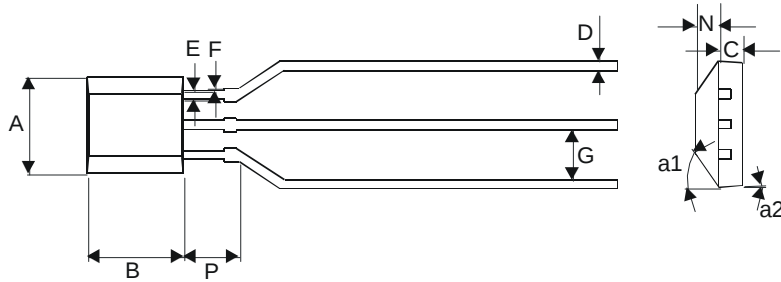


Sensor Location – To be updated

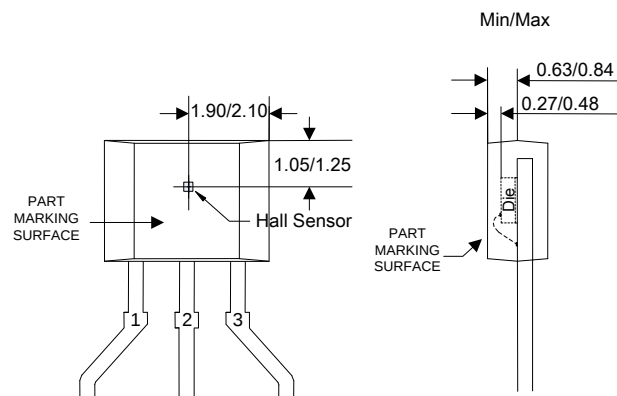
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

(4) Package Type: SIP-3 Ammo Pack



SIP-3 (Ammo Pack)		
Dim	Min	Max
A	3.9	4.3
a1	45° Typ	
a2	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

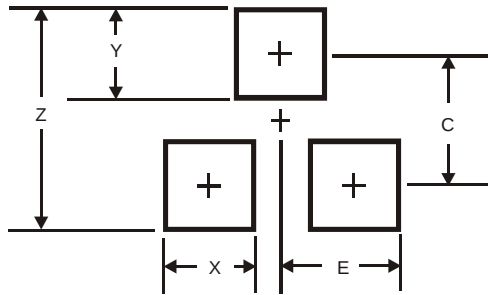


Sensor Location – To be updated

Suggested Pad Layout

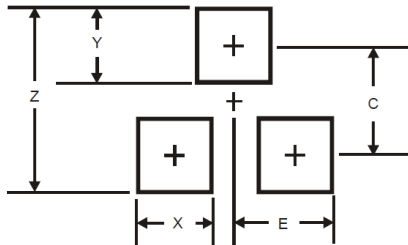
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

(2) Package Type: SOT23



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2015, Diodes Incorporated

www.diodes.com